

Inolux Surface Mount High Power Ultraviolet LED IN-K2PUV

Official Product	Product: IN-K2PUV			Data Sheet No.
Tentative Product	*****			IN-K2PUV
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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Label Specifications
INOLUX P/N:
I N - K 2 P U V - X X X X

Series Name	Substrate / Emitting Color	Customer Code
IN-K2 Inolux K2 package	K2 UV@390-420nm	XXXX Customer Product Code

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2010-A 2011-B 2012-C 2013-D . .	1:Jan. 2:Feb. ... A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C ... 26:Z 27:7 28:8 29:9 30:3 31:4	01~ZZ		000~ZZZ		

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Radiometric Power and Forward Voltage

(T_j =25 °C)

Part Number	Color	Performance at Test Current 700mA			
		Min. Radiometric Power (mW)		V _f	
		Min	Max	Min	Max
IN-K2PUV	UV	340	440	3.0	4.3

Part Number	Color	Performance at Test Current 350mA			
		Min. Radiometric Power (mW)		V _f	
		Min	Max	Min	Max
IN-K2PUV	UV	200	260	2.8	4.0

Note:

1. Radiometric Power is measured with an accuracy of ±10%
2. The forward voltage is measured with an accuracy of ±0.1V

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Product Characteristics

Absolute Maximum Ratings

(T_j = 25 °C)

Parameter	Rating
DC Forward Current (mA)	350~700mA
LED Junction Temperature	150°C
LED Operating Temperature	-40°C ~ 110°C
Storage Temperature	-40°C ~ 110°C
Soldering Temperature	Max. 260°C / Max. 10 sec. (JEDEC 020c)
ESD Sensitivity	2,000V HBM (JESD-22A-114-B)
Preconditioning	Acc. to JEDEC Level 2

Notes:

1. Never operate the LEDs in reverse bias.
2. Do not drive at rated current for more than 5 seconds without proper thermal management.
3. When the LEDs are illuminating, operating current should be decided after considering the packages maximum temperature.
4. Caution: These devices emit high intensity UV/NUV light. Necessary precautions must be taken during operation. Do not look directly into the light or look through the optical system when in operation. Protective eyewear should be worn at all times during operation.
5. Lens discoloration may occur with prolonged exposure to UV/NUV light. Lens material will need to be tested for UV/NUV light compatibility and durability.

Electro-Optical Characteristics

(T_j 25 °C)

Part Number	Color	Peak Wavelength (λ _p)		2θ _{1/2}	Temperature Coefficient of Vf (mV/°C)	Thermal Resistance Junction to Pad
		Min	Max		ΔVf / ΔTj	(°C/W) R _{θJ-L}
IN-K2PUV	UV	390	420	120	-3	10

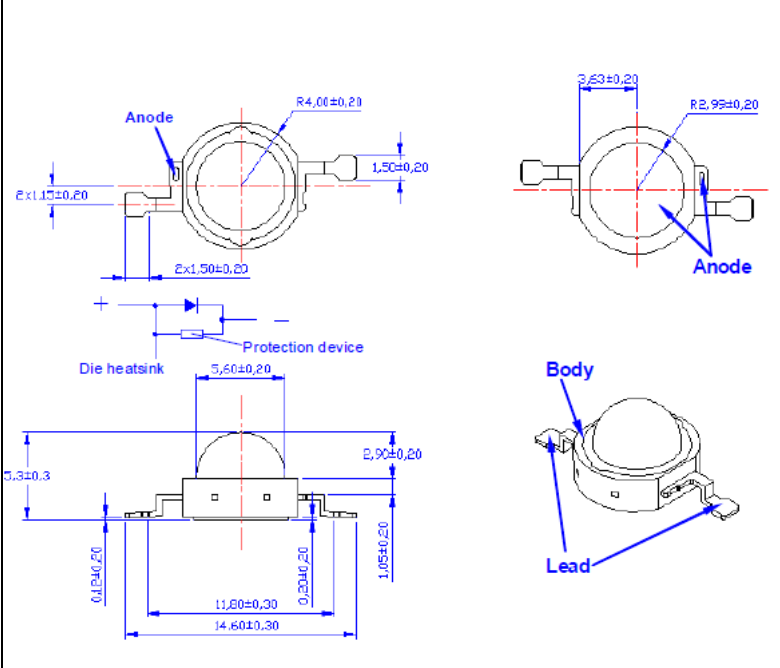
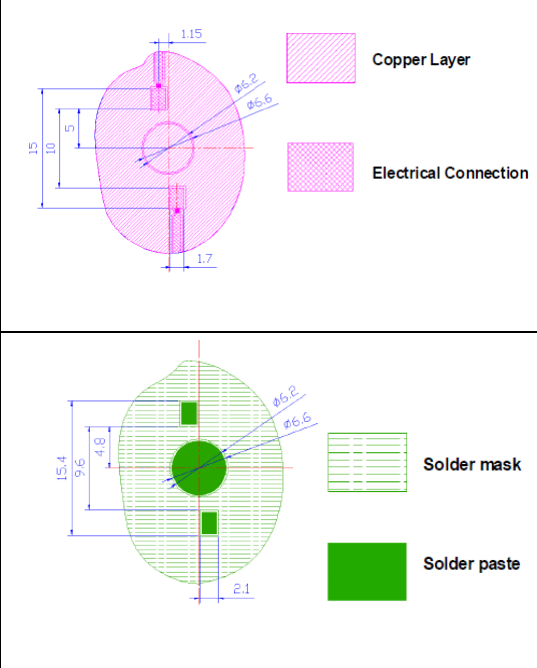
Notes:

1. The peak/dominant wavelength is measured with an accuracy of ±1nm.

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Package Outline Dimension
Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.13

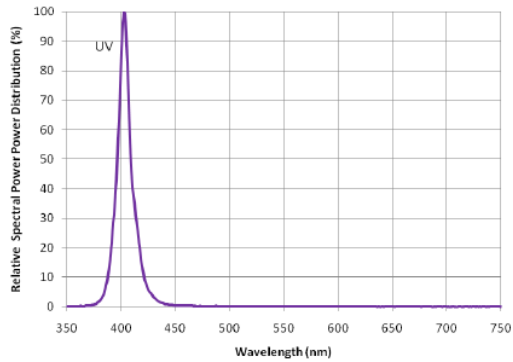
Outline Dimension	Solder Pattern
 <p>Technical drawings of the LED package showing outline dimensions and soldering pattern details. The drawings include a top view of the package with dimensions: $2 \times 1.15 \pm 0.20$, $2 \times 1.50 \pm 0.20$, $R4.00 \pm 0.20$, 1.50 ± 0.20, 3.63 ± 0.20, $R2.99 \pm 0.20$, 5.60 ± 0.20, 2.90 ± 0.20, 5.3 ± 0.3, 0.12 ± 0.20, 11.80 ± 0.30, 0.20 ± 0.20, 14.60 ± 0.30, and 1.05 ± 0.20. Labels include 'Anode', 'Die heatsink', 'Protection device', 'Body', and 'Lead'.</p>	 <p>Soldering pattern diagrams showing Copper Layer, Electrical Connection, Solder mask, and Solder paste. Dimensions include 1.15, 1.5, 10, 1.7, 15.4, 9.6, 4.8, 2.1, $\phi 6.2$, and $\phi 6.6$. Legend items: Copper Layer, Electrical Connection, Solder mask, Solder paste.</p>
<p>Soldering terminals may shift in the x, y direction.</p>	<p>Unit: mm</p>

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Characteristic Curves

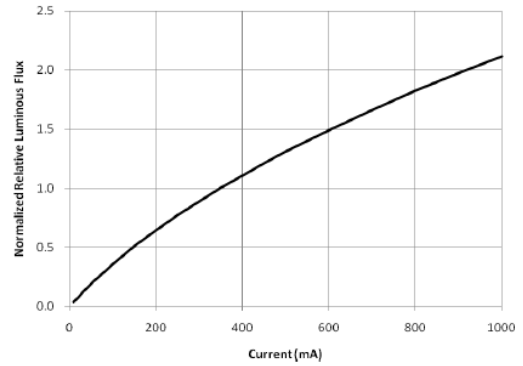
Relative Spectral Power Distribution, $T_a=25^\circ\text{C}$

UV



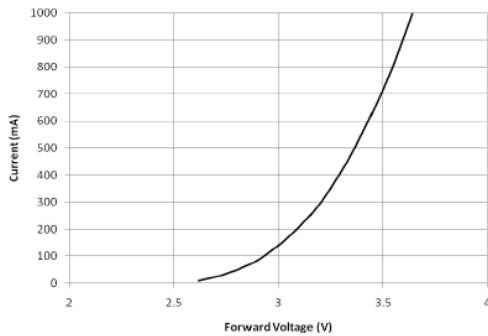
Typical Forward L-I Characteristics

UV



Typical Forward I-V Characteristics

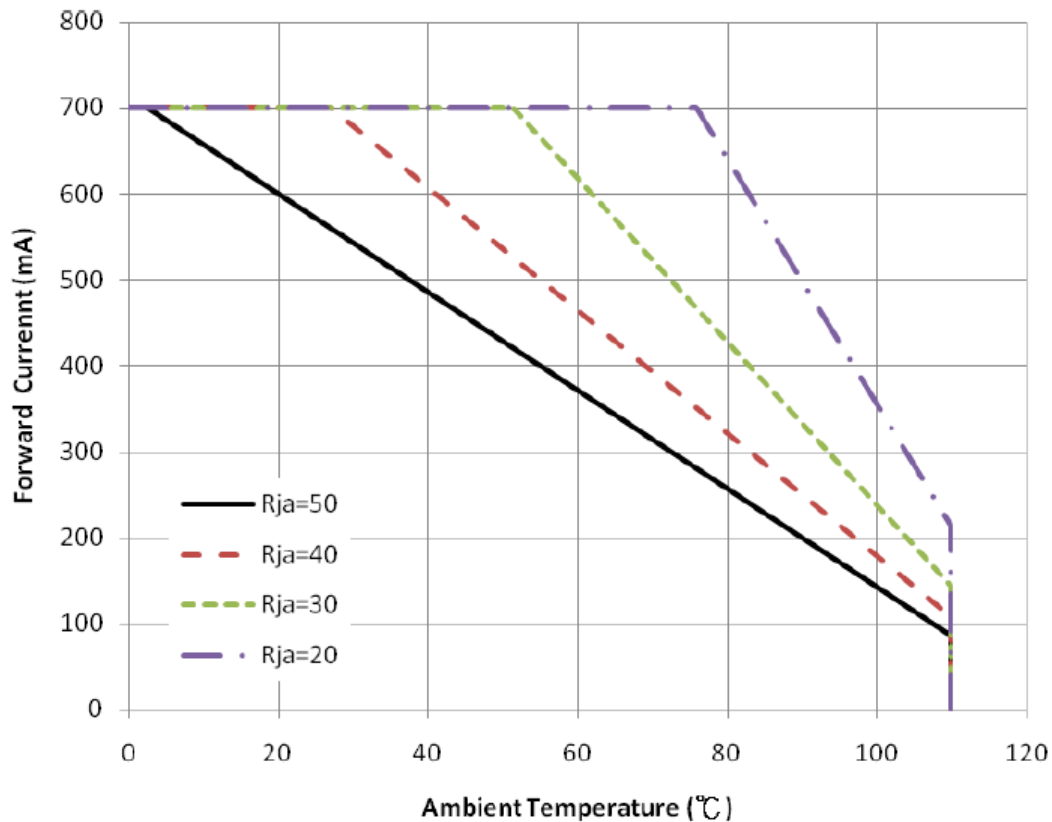
UV



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Thermal Design

Thermal design of the end product is important. The thermal resistance between the junction and the solder point (R_{ΘJ-S}) and the end product should be designed to minimize the thermal resistance from the solder point to ambient in order to optimize the emitter life and optical characteristics. The maximum operation current is determined by the plot of Allowable Forward Current vs. Ambient Temperature.



The junction temperature can be correlated to the thermal resistance between the junction and ambient (R_{ja}) by the following equation.

$$T_j = T_a + R_{ja} * W$$

T_j: LED junction temperature

T_a: Ambient temperature

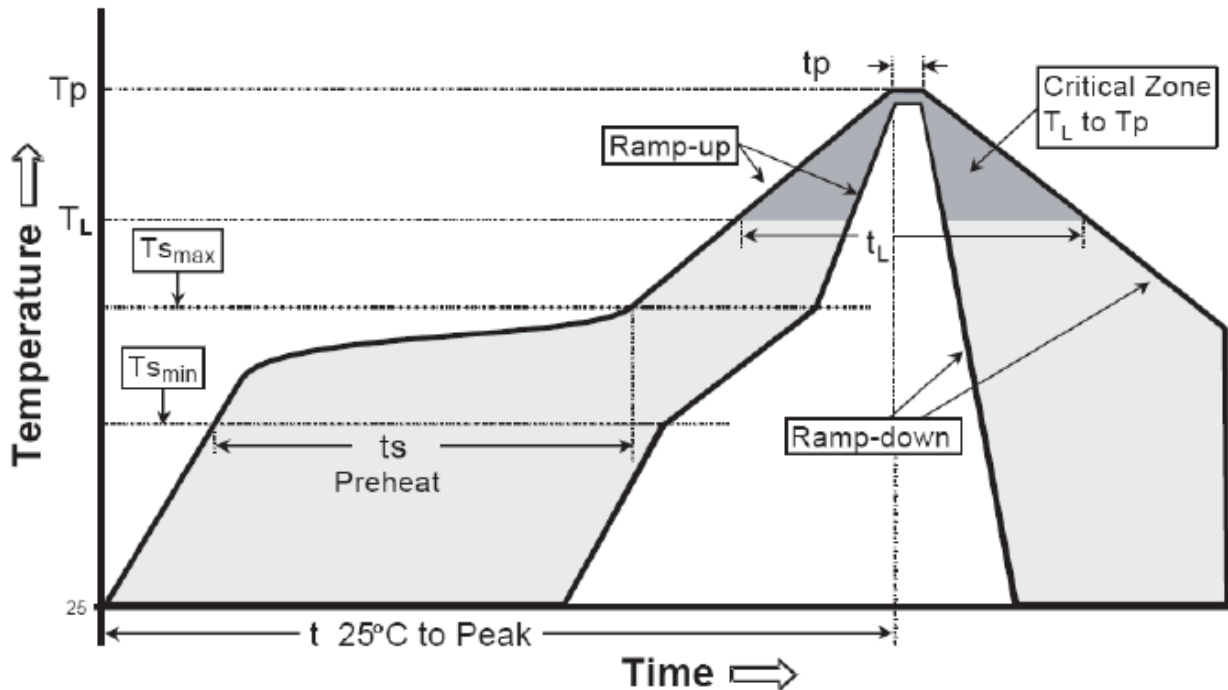
R_{ja}: Thermal resistance between the junction and ambient

W: Input power (I_F*V_F)

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Reflow Soldering

The LEDs can be soldered using the parameter listed below. As a general guideline, the users are suggested to follow the recommended soldering profile provided by the manufacturer of the solder paste. Although the recommended soldering conditions are specified in the list, reflow soldering at the lowest possible temperature is preferred for the LEDs.

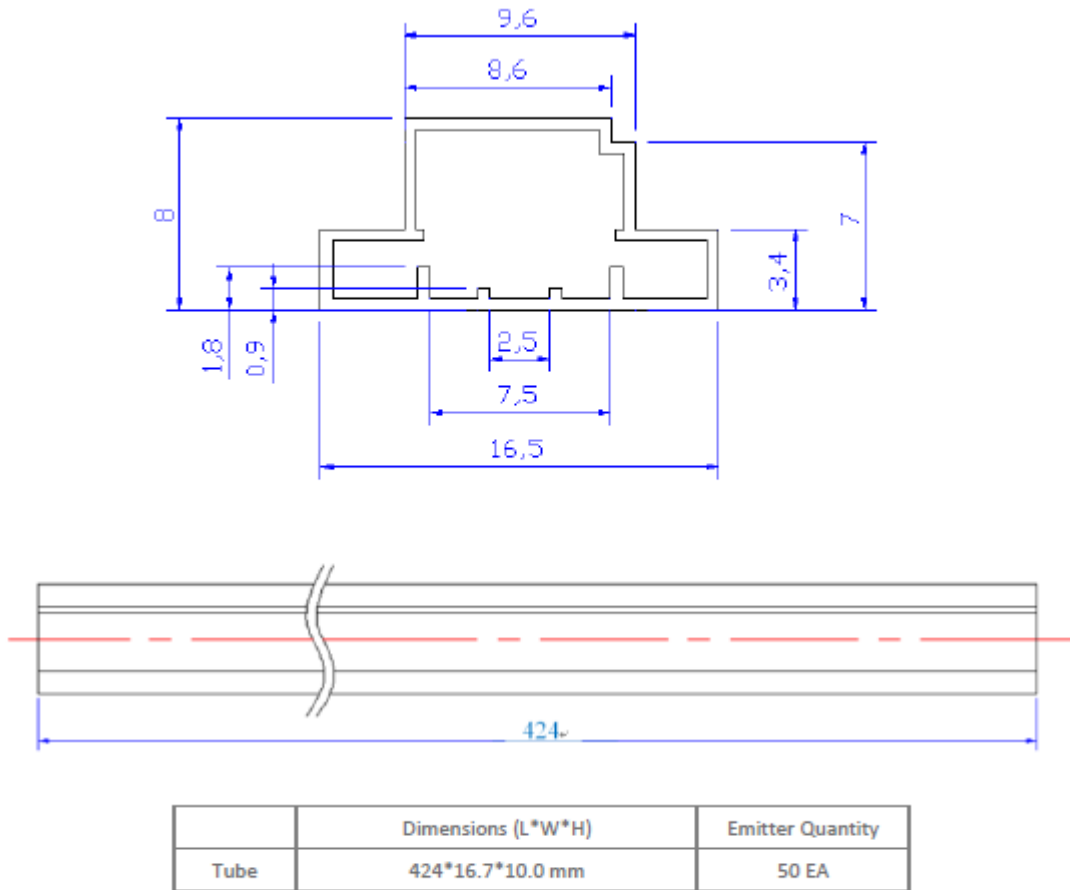


Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-up Rate ($T_{s_{max}}$ to T_p)	3°C/second max.	3°C/second max.
Preheat		
- Temperature Min($T_{s_{min}}$)	100°C	150°C
- Temperature Max($T_{s_{max}}$)	150°C	200°C
- Time($t_{s_{min}}$ to $t_{s_{max}}$)	60-120 seconds	60-180 seconds
Time maintained above:		
- Temperature(T_L)	183°C	217°C
- Time(t_L)	60-150 seconds	60-150 seconds
Peak/classification Temperature(T_p)	215°C	240°C
Time within 5°C of actual Peak Temperature(t_p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

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Packing Information

The carrier tape is conformal to EIA-481D



Note : All Dimensions are in millimeter

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Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial release		1.0	04-19-2014

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